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### **Cautions**

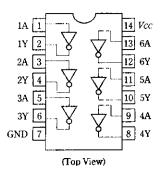
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# **■ PIN ARRANGEMENT**



# **M** ABSOLUTE MAXIMUM RATINGS

| Item                        | Symbol  | Ratings   |   |  |
|-----------------------------|---------|-----------|---|--|
| Supply voltage              | Vcc 7.0 |           | v |  |
| Input voltage               | Vin     | 7.0       | V |  |
| Output voltage              | Vout    | 30        |   |  |
| Operating temperature range | Topr    | -20 ~ +75 |   |  |
| Storage temperature range   | Tstg    | 65 ~ +150 |   |  |

# **RECOMMENDED OPERATING CONDITIONS**

| Item                        | Symbol | min  | typ  | max  | Unit |
|-----------------------------|--------|------|------|------|------|
| Supply voltage              | Vcc    | 4.75 | 5.00 | 5.25 | v    |
| High level output voltage   | Von    | _    |      | 30   | V    |
| Low level output current    | IOL    | -    | -    | 48   | mA   |
| Operating temperature range | Topr   | -20  | 25   | 75   | °C   |

# ■ ELECTRICAL CHARACTERISTICS (Ta = -20 ~ +75°C)

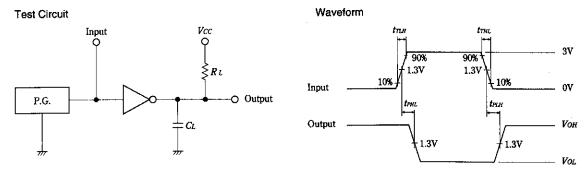
| Item                   | Symbol              | Test Conditions           |                   | min               | typ*     | max | Unit |    |
|------------------------|---------------------|---------------------------|-------------------|-------------------|----------|-----|------|----|
|                        | VIH                 |                           |                   |                   | 2.0      | _   | _    | V  |
| Input voltage          | VIL                 |                           |                   |                   | -        | _   | 0.8  | V  |
| Output voltage Vol.    |                     | 17. 17017                 | 77                | <i>IoL</i> = 24mA |          | -   | 0.4  | V  |
|                        | <i>Vcc</i> = 4.75V, | <i>Vih</i> = 2V           | <i>IoL</i> = 48mA | -                 |          | 0.5 | V    |    |
|                        | Іін                 | $V_{CC} = 5.25V$          | $V_{I} = 2.7V$    |                   |          | _   | 20   | μA |
| Input current  III  II | IIL                 | Vcc = 5.25V,              | $V_I = 0.4V$      |                   | <b>-</b> | -   | -0.4 | mA |
|                        | II                  | Vcc = 5.25V,              | V1 = 7V           |                   | _        | -   | 0.1  | mA |
| Output current         | Іон                 | Vcc = 4.75V,              | $V_{IL} = 0.8V$ , | <i>VoH</i> = 30V  | -        | _   | 250  | μΑ |
| Supply current Icch    | Іссн                | Vcc = 5.25V               |                   |                   |          | 23  | 48   | mA |
|                        | ICCL                | Vcc = 5.25V               |                   |                   | _        | 21  | 51   | mA |
| Input clamp voltage    | Vik                 | $V_{CC} = 4.75 \text{V},$ | IIN = -18mA       |                   | _        | _   | -1.5 | V  |

<sup>\*</sup>Vcc = 5V, Ta = 25°C

# **■ SWITCHING CHARACTERISTICS** (Vcc = 5V, Ta = 25°C)

| Item                        | Symbol | Test Conditions                      | min | typ | max | Unit |
|-----------------------------|--------|--------------------------------------|-----|-----|-----|------|
| Propagation delay time tpl. |        | -                                    | 10  | 15  | ns  |      |
|                             | tphl.  | $CL = 15 \text{pF}, RL = 110 \Omega$ | _   | 15  | 23  | ns   |

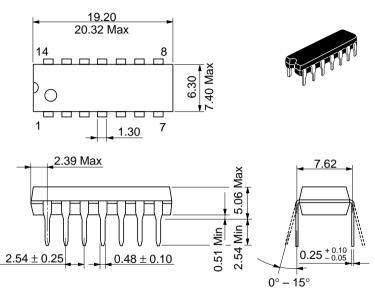
# **■ TESTING METHOD**



Notes) 1. Input pulse: PRR = 1MHz, duty cycle 50%, Zout = 50Ω, trun≤15ns. trnu≤6ns

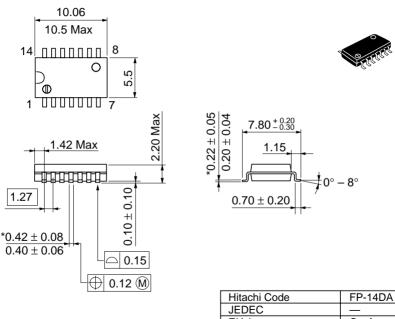
- 2. CL includes probe and jig capacitance.
- 3. All diodes are 1S2074(H)

Unit: mm



| Hitachi Code             | DP-14    |
|--------------------------|----------|
| JEDEC                    | Conforms |
| EIAJ                     | Conforms |
| Weight (reference value) | 0.97 g   |

Unit: mm



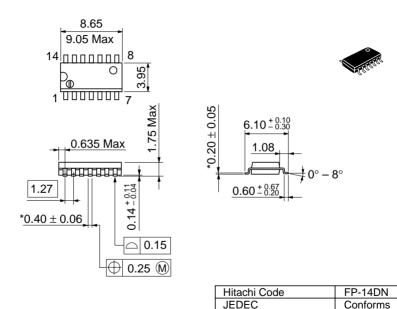
\*Dimension including the plating thickness
Base material dimension

\*Dimension including the plating thickness

Base material dimension

\*United States of The 14-57 of The 14

Unit: mm



EIAJ

Weight (reference value)

Conforms

0.13 g

\*Pd plating

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